

High speed IGBT in Trench and Fieldstop technology

Features

TRENCHSTOP™ 1200V technology offering

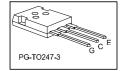
- very low V_{CEsat}
- low EMI
- maximum junction temperature 175°C
- qualified according to JEDEC for target applications
- Pb-free lead plating; RoHS compliant
- complete product spectrum and PSpice Models:

http://www.infineon.com/igbt/



- uninterruptible power supplies
- welding converters
- · converters with high switching frequency





| Туре | V CE | <i>l</i> c | V _{CEsat} , T _{vj} =25°C | T _{vjmax} | Marking | Package |
|-------------|-------------|------------|--|--------------------|----------|------------|
| IGW15N120H3 | 1200V | 15A | 2.05V | 175°C | G15H1203 | PG-TO247-3 |

Maximum ratings

| Parameter | Symbol | Value | Unit |
|---|---------------------|----------------|------|
| Collector-emitter voltage | VcE | 1200 | V |
| DC collector current, limited by T_{vjmax} $T_C = 25^{\circ}C$ $T_C = 100^{\circ}C$ | <i>l</i> c | 30.0 15.0 | А |
| Pulsed collector current, & limited by T _{vjmax} | Cpuls | 60.0 | А |
| Turn off safe operating area $V_{CE} \le 1200V$, $T_{vj} \le 175^{\circ}C$ | - | 60.0 | А |
| Gate-emitter voltage | V _{GE} | ±20 | V |
| Short circuit withstand time V_{GE} = 15.0V, $V_{\text{CC}} \le 600$ V, $T_{\text{vj}} \le 175^{\circ}$ C Allowed number of short circuits < 1000 Time between short circuits: ≥ 1.0 s | <i>t</i> sc | 10 | μs |
| Power dissipation $T_C = 25^{\circ}C$ Power dissipation $T_C = 100^{\circ}C$ | P _{tot} | 217.0 105.0 | W |
| Operating junction temperature | \mathcal{T}_{vj} | -40+175 | °C |
| Storage temperature | \mathcal{T}_{stg} | -55+150 | °C |
| Soldering temperature, wavesoldering 1.6 mm (0.063 in.) from case for 10s | | 260 | °C |
| Mounting torque, M3 screw Maximum of mounting processes: 3 | М | 0.6 | Nm |



Thermal Resistance

| Parameter | Symbol | Conditions | Max. Value | Unit |
|--|---------------|------------|------------|------|
| Characteristic | | | | |
| IGBT thermal resistance, junction - case | $R_{th(j-c)}$ | | 0.70 | K/W |
| Thermal resistance junction - ambient | $R_{th(j-a)}$ | | 40 | K/W |

Electrical Characteristic, at T_{vj} = 25°C, unless otherwise specified

| Donomotor | Cumbal | Conditions | Value | | | Unit |
|--------------------------------------|-------------------|--|-------------|----------------------|-----------------|------|
| Parameter | Symbol Conditions | | min. | typ. | max. | Uill |
| Static Characteristic | | | | | | |
| Collector-emitter breakdown voltage | V(BR)CES | V _{GE} = 0V, / _C = 0.50mA | 1200 | - | - | V |
| Collector-emitter saturation voltage | V CEsat | $V_{GE} = 15.0V$, $f_{C} = 15.0A$ $T_{Vj} = 25^{\circ}C$ $T_{Vj} = 125^{\circ}C$ $T_{Vj} = 175^{\circ}C$ | - - - | 2.05 2.50 2.70 | 2.40 - - | V |
| Gate-emitter threshold voltage | VGE(th) | $I_C = 0.50$ mA, $V_{CE} = V_{GE}$ | 5.0 | 5.8 | 6.5 | V |
| Zero gate voltage collector current | /ces | $V_{CE} = 1200V, V_{GE} = 0V$ $T_{Vj} = 25^{\circ}C$ $T_{Vj} = 175^{\circ}C$ | | - - | 250.0 2500.0 | μA |
| Gate-emitter leakage current | /GES | V _{CE} = 0V, V _{GE} = 20V | - | - | 600 | nA |
| Transconductance | g_{fs} | V _{CE} = 20V, / _C = 15.0A | - | 7.5 | - | S |

Electrical Characteristic, at T_{vj} = 25°C, unless otherwise specified

| Doromotor | Sumbal Conditions | | | Value | | |
|--|-----------------------|---|---|-------|------|------|
| Parameter | Symbol | symbol Conditions | | typ. | max. | Unit |
| Dynamic Characteristic | | | | | | |
| Input capacitance | Cies | | - | 875 | - | |
| Output capacitance | Coes | $V_{CE} = 25V$, $V_{GE} = 0V$, $f = 1MHz$ | | 60 | - | pF |
| Reverse transfer capacitance | Cres | | - | 45 | - | |
| Gate charge | <i>Q</i> _G | $V_{CC} = 960V$, $I_{C} = 15.0A$, $V_{GE} = 15V$ | - | 75.0 | - | nC |
| Internal emitter inductance measured 5mm (0.197 in.) from case | e ∠ _E | | - | 13.0 | - | nH |
| Short circuit collector current Max. 1000 short circuits Time between short circuits: ≥ 1.0s | Ic(sc) | $V_{GE} = 15.0V, V_{CC} \le 600V,$ $T_{Vj} \le 175^{\circ}C, t_{SC} \le 10\mu s$ | - | 52 | - | А |

2



Switching Characteristic, Inductive Load, at T_{vj} = 25°C

| Damanatan | O | O and distinguish | Value | | | 11:4 |
|------------------------|---------------------------|--|-----------|------|------|------|
| Parameter | Symbol | Conditions | min. typ. | | max. | Unit |
| IGBT Characteristic | • | | | | | |
| Turn-on delay time | <i>t</i> _{d(on)} | $T_{Vj} = 25^{\circ}\text{C},$ $V_{CC} = 600\text{V}, I_{C} = 15.0\text{A},$ $V_{GE} = 0.0/15.0\text{V},$ $V_{GG} = 35.0\Omega, I_{CG} = 95\text{nH},$ $I_{CG} = 67\text{pF},$ $I_{CG} = 67\text{pF},$ $I_{CG} = 67\text{pF},$ Energy losses include "tail" and | - | 21 | - | ns |
| Rise time | <i>t</i> _r | | - | 34 | - | ns |
| Turn-off delay time | <i>t</i> d(off) | | - | 260 | - | ns |
| Fall time | <i>t</i> f | | - | 14 | - | ns |
| Turn-on energy | <i>E</i> on | | - | 1.10 | - | mJ |
| Turn-off energy | E _{off} | diode (IKW15N120H3) reverse recovery. | - | 0.45 | - | mJ |
| Total switching energy | <i>E</i> ts | | - | 1.55 | - | mJ |

Switching Characteristic, Inductive Load, at T_{vj} = 175°C

| Danis and an | O | O andition a | Value | | | 11:4 |
|------------------------|---------------------------|---|-----------|------|------|------|
| Parameter | Symbol | Conditions | min. typ. | | max. | Unit |
| IGBT Characteristic | • | | | | | • |
| Turn-on delay time | <i>t</i> _{d(on)} | $T_{Vj} = 175^{\circ}\text{C},$ $V_{CC} = 600\text{V}, I_{C} = 15.0\text{A},$ $V_{GE} = 0.0/15.0\text{V},$ $V_{GG} = 35.0\Omega, I_{CG} = 95\text{nH},$ $I_{CG} = 67\text{pF},$ $I_{CG} = 67\text{pF},$ I_{CG} | - | 19 | - | ns |
| Rise time | <i>t</i> r | | - | 30 | - | ns |
| Turn-off delay time | <i>t</i> d(off) | | - | 327 | - | ns |
| Fall time | <i>t</i> f | | - | 43 | - | ns |
| Turn-on energy | <i>E</i> on | | - | 1.60 | - | mJ |
| Turn-off energy | E _{off} | diode (IKW15N120H3) reverse recovery. | - | 0.90 | - | mJ |
| Total switching energy | Ets | , | - | 2.50 | - | mJ |

3



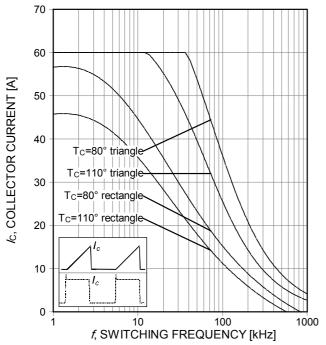


Figure 1. Collector current as a function of switching frequency ($T_{\rm j} \le 175^{\circ}{\rm C}$, D=0.5, $V_{\rm CE}=600{\rm V}$, $V_{\rm GE}=15/0{\rm V}$, $R_{\rm G}=35\Omega$)

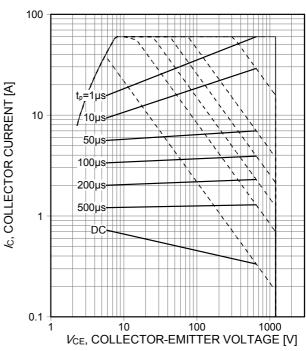


Figure 2. Forward bias safe operating area (D=0, T_C =25°C, T_j ≤175°C; V_{GE} =15V)

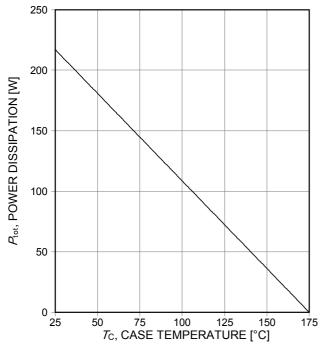


Figure 3. Power dissipation as a function of case temperature (T≤175°C)

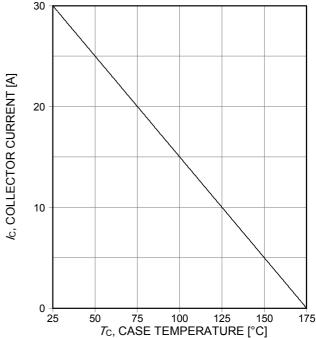


Figure 4. Collector current as a function of case temperature (V_{GE}≥15V, T_j≤175°C)



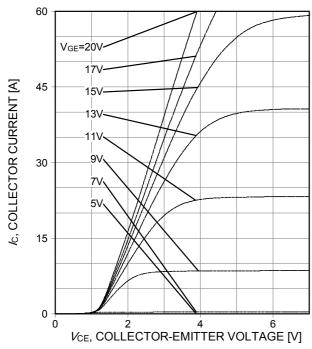


Figure 5. Typical output characteristic $(T_i=25^{\circ}C)$

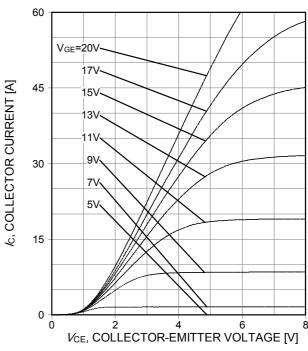


Figure 6. Typical output characteristic $(T_i=175^{\circ}\text{C})$

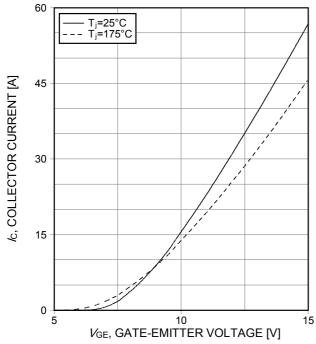


Figure 7. Typical transfer characteristic $(V_{CE}=20V)$

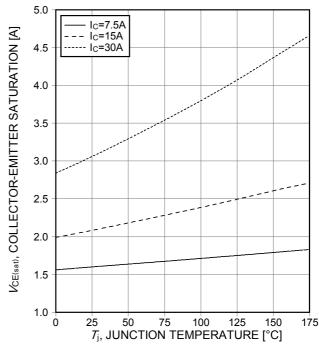


Figure 8. Typical collector-emitter saturation voltage as a function of junction temperature ($V_{\rm GE}$ =15V)



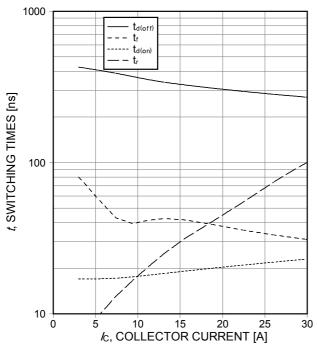


Figure 9. Typical switching times as a function of collector current (ind. load, *T*_j=175°C, *V*_{CE}=600V,

 $V_{GE}=15/0V$, $R_{G}=35\Omega$, test circuit in Fig. E)

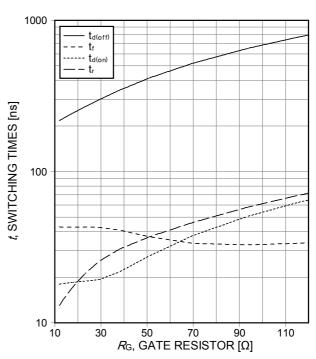


Figure 10. Typical switching times as a function of gate resistor
(ind. load, T_j =175°C, V_{CE} =600V, V_{GE} =15/0V, I_{CE} =15A, test circuit in Fig. E)

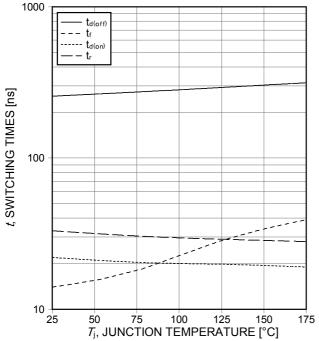


Figure 11. Typical switching times as a function of junction temperature (ind. load, VcE=600V, VGE=15/0V, Vc=15A, RG=35Ω, test circuit in Fig. E)

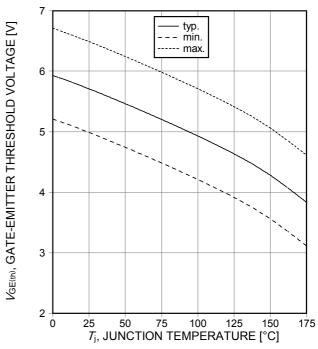


Figure 12. Gate-emitter threshold voltage as a function of junction temperature (/c=0.5mA)



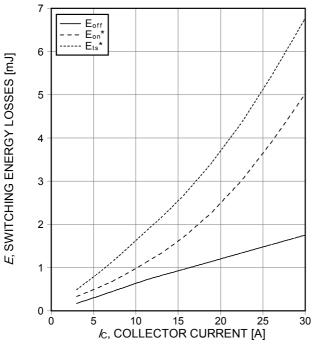


Figure 13. Typical switching energy losses as a function of collector current (ind. load, T_j =175°C, V_{CE} =600V, V_{GE} =15/0V, R_{G} =35 Ω , test circuit in Fig. E)

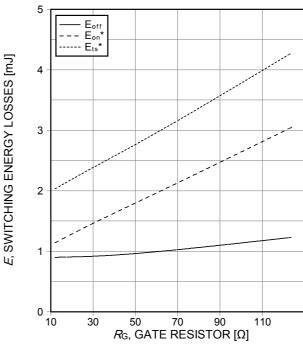


Figure 14. Typical switching energy losses as a function of gate resistor (ind. load, Tj=175°C, VcE=600V, VGE=15/0V, Ic=15A, test circuit in Fig. E)

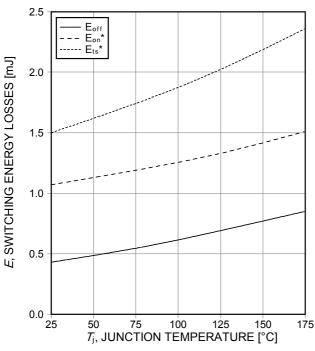


Figure 15. Typical switching energy losses as a function of junction temperature (ind load, V_{CE} =600V, V_{GE} =15/0V, I_{C} =15A, I_{CE} =35 Ω , test circuit in Fig. E)

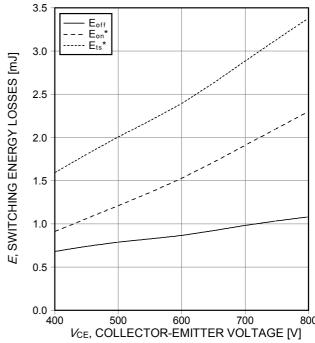


Figure 16. Typical switching energy losses as a function of collector emitter voltage (ind. load, T_j =175°C, V_{GE} =15/0V, I_{C} =15A, R_{G} =35 Ω , test circuit in Fig. E)



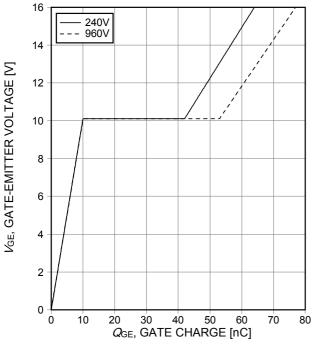


Figure 17. Typical gate charge (/c=15A)

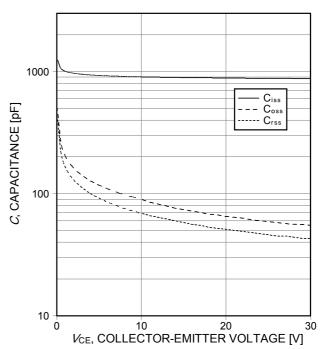


Figure 18. Typical capacitance as a function of collector-emitter voltage (V_{GE}=0V, f=1MHz)

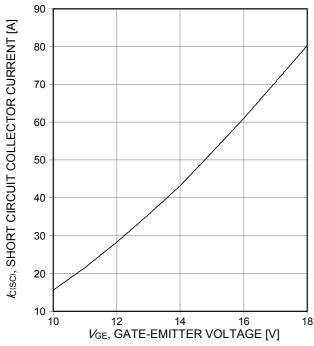


Figure 19. Typical short circuit collector current as a function of gate-emitter voltage (Vc∈≤600V, start at Tj=25°C)

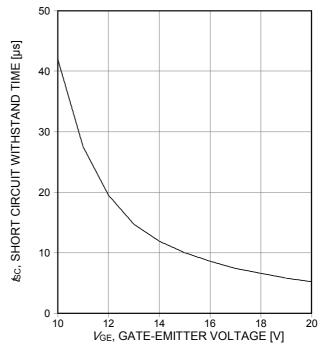


Figure 20. Short circuit withstand time as a function of gate-emitter voltage ($V_{\text{CE}} \le 600 \text{V}$, start at $T_{\text{J}} \le 150 ^{\circ}\text{C}$)



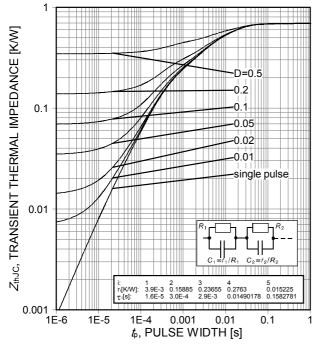
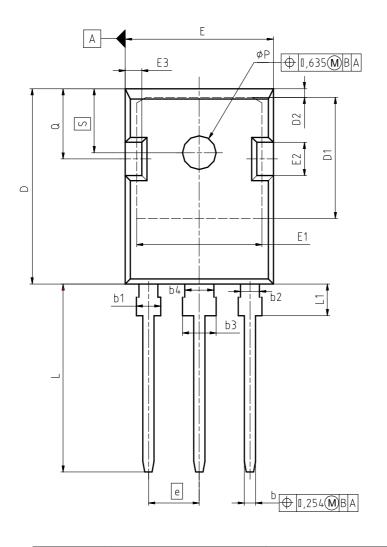


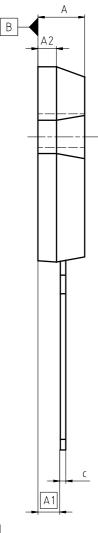
Figure 21. IGBT transient thermal impedance $(D=t_0/T)$

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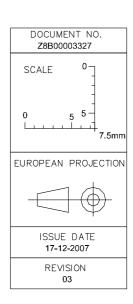


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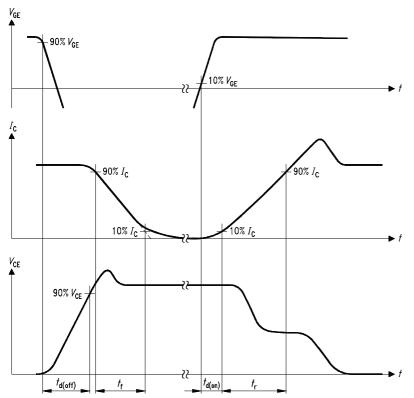




| DIM | MILLIM | MILLIMETERS | | IES |
|-----|--------|-------------|-------|-------|
| DIM | MIN | MAX | MIN | MAX |
| Α | 4.90 | 5.16 | 0.193 | 0.203 |
| A1 | 2.27 | 2.53 | 0.089 | 0.099 |
| A2 | 1.85 | 2.11 | 0.073 | 0.083 |
| b | 1.07 | 1.33 | 0.042 | 0.052 |
| b1 | 1.90 | 2.41 | 0.075 | 0.095 |
| b2 | 1.90 | 2.16 | 0.075 | 0.085 |
| b3 | 2.87 | 3.38 | 0.113 | 0.133 |
| b4 | 2.87 | 3.13 | 0.113 | 0.123 |
| С | 0.55 | 0.68 | 0.022 | 0.027 |
| D | 20.82 | 21.10 | 0.820 | 0.831 |
| D1 | 16.25 | 17.65 | 0.640 | 0.695 |
| D2 | 1.05 | 1.35 | 0.041 | 0.053 |
| E | 15.70 | 16.03 | 0.618 | 0.631 |
| E1 | 13.10 | 14.15 | 0.516 | 0.557 |
| E2 | 3.68 | 5.10 | 0.145 | 0.201 |
| E3 | 1.68 | 2.60 | 0.066 | 0.102 |
| е | 5.4 | 44 | 0.2 | 14 |
| N | 3 | | (| 3 |
| L | 19.80 | 20.31 | 0.780 | 0.799 |
| L1 | 4.17 | 4.47 | 0.164 | 0.176 |
| øΡ | 3.50 | 3.70 | 0.138 | 0.146 |
| Q | 5.49 | 6.00 | 0.216 | 0.236 |
| S | 6.04 | 6.30 | 0.238 | 0.248 |







 di_{F}/dt $t_{rr} = t_{S} + t_{F}$ $Q_{rr} = Q_{S} + Q_{F}$ t_{rr} t_{rr} Q_{S} Q_{F} Q_{F

Figure C. Definition of diodes switching characteristics

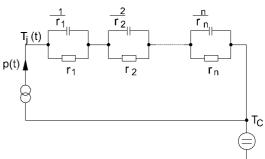
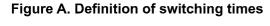
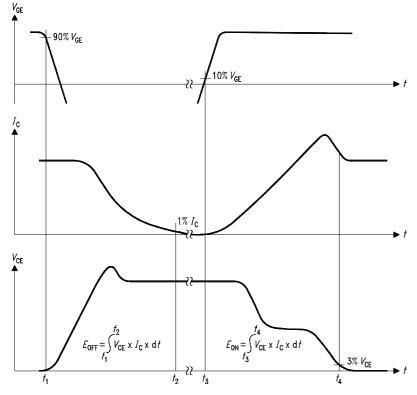


Figure D. Thermal equivalent circuit





V_{DC}

DUT
(Diode)

L
C
C,

DUT
(IGBT)

Figure E. Dynamic test circuit Leakage inductance L= 180nH, Stray capacitor C_o = 40pF, Relief capacitor C_r = 1nF (only for ZVT switching)

Figure B. Definition of switching losses





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